



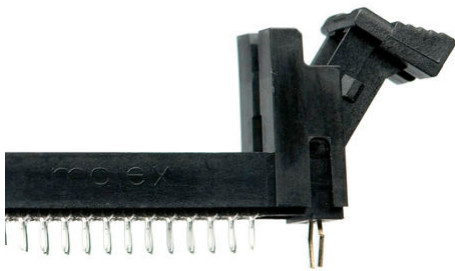
Part Number : [787261023](#)

Product Description : DDR4 DIMM Socket, Vertical Through-Hole, 0.76µm Gold Plating, 288 Circuits, PCB Thickness 2.36mm, Tail Length 3.18mm, Blue Housing, White Latch

Series Number : 78726

Status : Obsolete

Product Category : Memory Module Connectors



Documents and Resources

Drawings

- [787261023 sd.pdf](#)
- [PK-78726-001-000.pdf](#)
- [787260005-000.pdf](#)
- [EE-78726-002-001.pdf](#)
- [EE-78726-004-001.pdf](#)
- [787260005-000.zip](#)
- [SP-78726-002-001.zip](#)
- [SP-78726-004-001.zip](#)

Specifications

- [AS-78726-001-001.pdf](#)
- [AS-78726-002-001.pdf](#)
- [PS-78726-001-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)7771-DC (04 Feb 2026)

EU RoHS	Compliant per EU 2015/863
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Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Obsolete
Category	Memory Module Connectors
Series	78726
Description	DDR4 DIMM Socket, Vertical Through-Hole, 0.76µm Gold Plating, 288 Circuits, PCB Thickness 2.36mm, Tail Length 3.18mm, Blue Housing, White Latch
Component Type	Socket
JEDEC Outline	MO-309
Product Name	DDR4 DIMM
UPC	887191399348

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	0.75A
Voltage - Maximum	29V AC (RMS)/DC

Physical

Circuits (Loaded)	288
Circuits (maximum)	288
Durability (mating cycles max)	25
Entry Angle	Vertical (Top Entry)
Flammability	94V-0
Housing Color	Blue
Keying to Mating Part	None
Latch Color	White
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Nylon
Net Weight	6.387/g
Packaging Type	Tray
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	2.36mm
PC Tail Length	3.18mm
Pitch - Mating Interface	0.85mm
Pitch - Termination Interface	0.85mm
Plating min - Mating	0.762µm
Plating min - Termination	2.540µm
Temperature Range - Operating	-55° to +85°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	5
Lead-Free Process Capability	SMC&WAVE
Max-Cycle	2
Max-Temp	260

Obsolete